

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of) **MAIL STOP AMENDMENT**
Akihiro Goto et al.)
Application No.: 10/586,908) Group Art Unit: 2825
Filed: July 24, 2006) Examiner: NGHIA M DOAN
For: WIRING DESIGN SUPPORT) Confirmation No.: 1812
APPARATUS FOR BOND WIRE OF)
SEMICONDUCTOR DEVICES)

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated January 26, 2009, please amend the above-identified patent application as follows: